



Product Change Notification

102592 - 00

Information in this document is provided in connection with Intel® products. No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Intel's Terms and Conditions of Sale for such products, Intel assumes no liability whatsoever, and Intel disclaims any express or implied warranty, relating to sale and/or use of Intel® products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Intel® products are not intended for use in medical, life saving, or life sustaining applications. Intel may make changes to specifications and product descriptions at any time, without notice.

Copyright © Intel Corporation 2002. Third-party brands and names are the property of their respective owners.

Intel, Insight960, Intel386, Intel486, Intel740, IntelDX2, IntelDX4, IntelSX2, Intel GigaBlade, Intel StrataFlash, Intel Xeon™, Intel XScale, Itanium™, OverDrive, Pentium®, Pentium® II Xeon™, Pentium® III Xeon™, Solutions960, LANDesk, Celeron®, FlashFile, i386, i486, i960, iCAT, iCOMP, Intel SingleDriver technology, EtherExpress™, AnyPoint is a trademark or registered trademark of Intel Corporation or its subsidiaries in the United States and other countries.

Learn how to use Intel Trade Marks and Brands correctly at <http://www.intel.com/intel/legal/tmusage2.htm>.

Change Notification #: # 102592 - 00
Change Title: Intel® 82845GL, PCN 102592-00,
FFF, 845GL A1 to 845GL B1
Stepping Conversion
Date of PCN Publication: Thursday, September 26, 2002

Type of Change Notification:
Form-Fit-Function

Key Characteristics of the Change:
Product Design

Forecasted Key Milestones:

Date of Samples Availability:	Nov 04, 2002
Date of Qualification Data Availability:	Dec 23, 2002
Date Customer Must be Ready to Receive Post-Conversion Material:	Jan 06, 2003
Date of First Availability of Post-Conversion Material:	Jan 06, 2003

The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.

Description of Change to the Customer:

The Intel® 845GL chipset component is converting from A1 to B1 stepping.

For technical details of the Intel® 845GL chipset component, please refer to the latest Spec Update available on FDBL.

Customer Impact of Change and Recommended Action:

The 845GL B1 is pin-to-pin compatible with the A1 and does not require any motherboard modifications. Design changes have been made to the 845GL B1 and will require customers to perform re-qualification. Please see the 845GL B1 spec update for any BIOS changes required.

**Products Affected / Intel Ordering Codes:
Component Products Table**

Pre-conversion Product Code	Pre-conversion Spec/ROM	Pre-conversion MM#	Post-conversion Product Code	Post-conversion Spec/ROM	Post-conversion MM#
RG82845GL	S L66G	845252	RG82845GL RG82845GL	Q D73 S L6PT	850155 850148

Reference Documents / Attachments:

Document:

Location #:

PCN Revision History:

Date of Revision:

Revision Number:

Reason:

Sep 26, 2002

00

Originally Published PCN